

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Hiroyuki OSADA et al.

Application No.: 10/551,809

Confirmation No.: 6770

Filed: September 30, 2005

Art Unit: 1641

For: METHOD OF FIXING LOW-MOLECULAR
COMPOUND TO SOLID-PHASE SUPPORT

Examiner: L. V. Cook

RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Madam:

INTRODUCTORY COMMENTS

In response to the Office Action dated May 1, 2009, the due date having been extended for one (1) month, the following remarks are respectfully submitted.

Remarks/Arguments begin on page 2 of this paper.